

Welcome to [E-XFL.COM](https://www.e-xfl.com)

What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	8051
Core Size	8-Bit
Speed	50MHz
Connectivity	EBI/EMI, SMBus (2-Wire/I ² C), SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, Temp Sensor, WDT
Number of I/O	32
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8.25K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x8b, 8x10b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-TQFP
Supplier Device Package	64-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f127r

C8051F120/1/2/3/4/5/6/7 C8051F130/1/2/3

Figure 20.4. 4-Wire Single Master and Slave Mode Connection Diagram	276
Figure 20.5. Master Mode Data/Clock Timing	278
Figure 20.6. Slave Mode Data/Clock Timing (CKPHA = 0)	279
Figure 20.7. Slave Mode Data/Clock Timing (CKPHA = 1)	279
Figure 20.8. SPI Master Timing (CKPHA = 0)	283
Figure 20.9. SPI Master Timing (CKPHA = 1)	283
Figure 20.10. SPI Slave Timing (CKPHA = 0)	284
Figure 20.11. SPI Slave Timing (CKPHA = 1)	284
21. UART0	
Figure 21.1. UART0 Block Diagram	287
Figure 21.2. UART0 Mode 0 Timing Diagram	288
Figure 21.3. UART0 Mode 0 Interconnect.....	288
Figure 21.4. UART0 Mode 1 Timing Diagram	289
Figure 21.5. UART0 Modes 2 and 3 Timing Diagram	291
Figure 21.6. UART0 Modes 1, 2, and 3 Interconnect Diagram	292
Figure 21.7. UART Multi-Processor Mode Interconnect Diagram	294
22. UART1	
Figure 22.1. UART1 Block Diagram	299
Figure 22.2. UART1 Baud Rate Logic	300
Figure 22.3. UART Interconnect Diagram	301
Figure 22.4. 8-Bit UART Timing Diagram.....	301
Figure 22.5. 9-Bit UART Timing Diagram.....	302
Figure 22.6. UART Multi-Processor Mode Interconnect Diagram	303
23. Timers	
Figure 23.1. T0 Mode 0 Block Diagram.....	310
Figure 23.2. T0 Mode 2 Block Diagram.....	311
Figure 23.3. T0 Mode 3 Block Diagram.....	312
Figure 23.4. T2, 3, and 4 Capture Mode Block Diagram	318
Figure 23.5. Tn Auto-reload (T2,3,4) and Toggle Mode (T2,4) Block Diagram	319
24. Programmable Counter Array	
Figure 24.1. PCA Block Diagram.....	325
Figure 24.2. PCA Counter/Timer Block Diagram.....	326
Figure 24.3. PCA Interrupt Block Diagram	328
Figure 24.4. PCA Capture Mode Diagram.....	329
Figure 24.5. PCA Software Timer Mode Diagram	330
Figure 24.6. PCA High Speed Output Mode Diagram.....	331
Figure 24.7. PCA Frequency Output Mode	332
Figure 24.8. PCA 8-Bit PWM Mode Diagram	333
Figure 24.9. PCA 16-Bit PWM Mode.....	334
25. JTAG (IEEE 1149.1)	

C8051F120/1/2/3/4/5/6/7 C8051F130/1/2/3

Table 4.1. Pin Definitions (Continued)

Name	Pin Numbers				Type	Description
	'F120 'F122 'F124 'F126	'F121 'F123 'F125 'F127	'F130 'F132	'F131 'F133		
DAC1	99	63			A Out	Digital to Analog Converter 1 Voltage Output. (See DAC Specification for complete description).
P0.0	62	55	62	55	D I/O	Port 0.0. See Port Input/Output section for complete description.
P0.1	61	54	61	54	D I/O	Port 0.1. See Port Input/Output section for complete description.
P0.2	60	53	60	53	D I/O	Port 0.2. See Port Input/Output section for complete description.
P0.3	59	52	59	52	D I/O	Port 0.3. See Port Input/Output section for complete description.
P0.4	58	51	58	51	D I/O	Port 0.4. See Port Input/Output section for complete description.
ALE/P0.5	57	50	57	50	D I/O	ALE Strobe for External Memory Address bus (multiplexed mode) Port 0.5 See Port Input/Output section for complete description.
$\overline{\text{RD}}$ /P0.6	56	49	56	49	D I/O	$\overline{\text{RD}}$ Strobe for External Memory Address bus Port 0.6 See Port Input/Output section for complete description.
$\overline{\text{WR}}$ /P0.7	55	48	55	48	D I/O	$\overline{\text{WR}}$ Strobe for External Memory Address bus Port 0.7 See Port Input/Output section for complete description.
AIN2.0/A8/P1.0	36	29	36	29	A In D I/O	ADC2 Input Channel 0 (See ADC2 Specification for complete description). Bit 8 External Memory Address bus (Non-multiplexed mode) Port 1.0 See Port Input/Output section for complete description.
AIN2.1/A9/P1.1	35	28	35	28	A In D I/O	Port 1.1. See Port Input/Output section for complete description.

C8051F120/1/2/3/4/5/6/7 C8051F130/1/2/3

The Temperature Sensor transfer function is shown in Figure 5.2. The output voltage (V_{TEMP}) is the PGA input when the Temperature Sensor is selected by bits AMX0AD3-0 in register AMX0SL; this voltage will be amplified by the PGA according to the user-programmed PGA settings. Typical values for the Slope and Offset parameters can be found in Table 5.1.

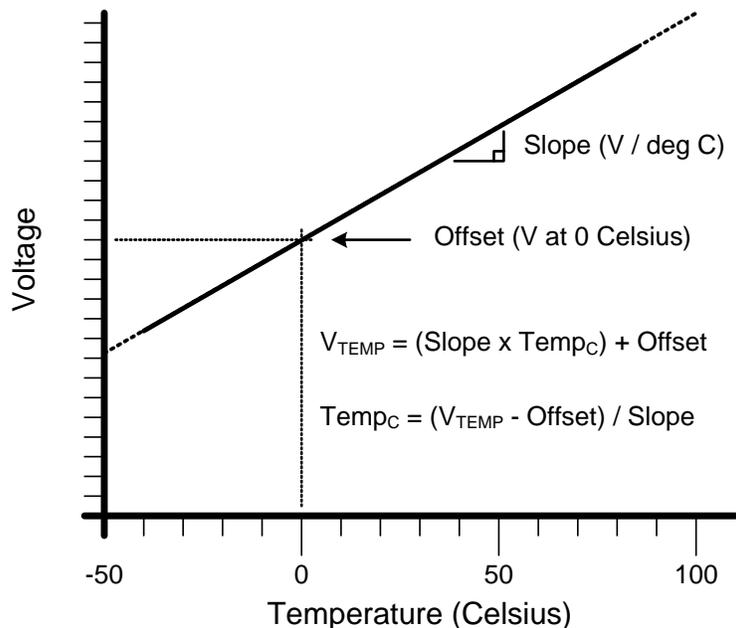
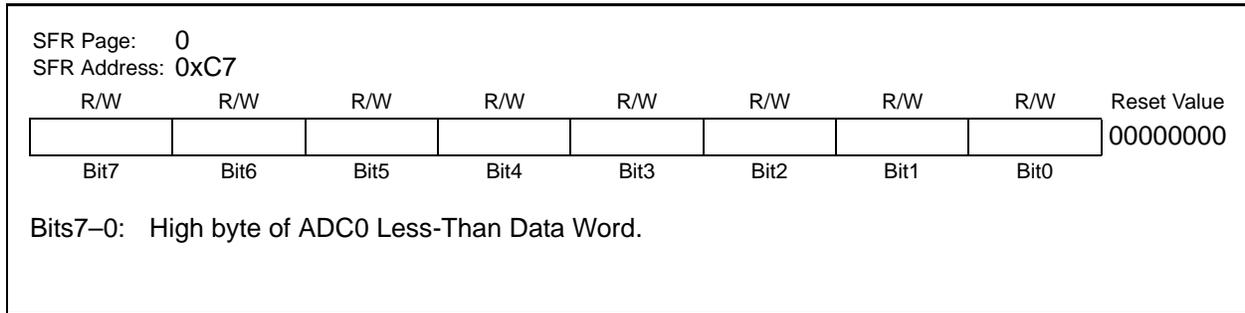


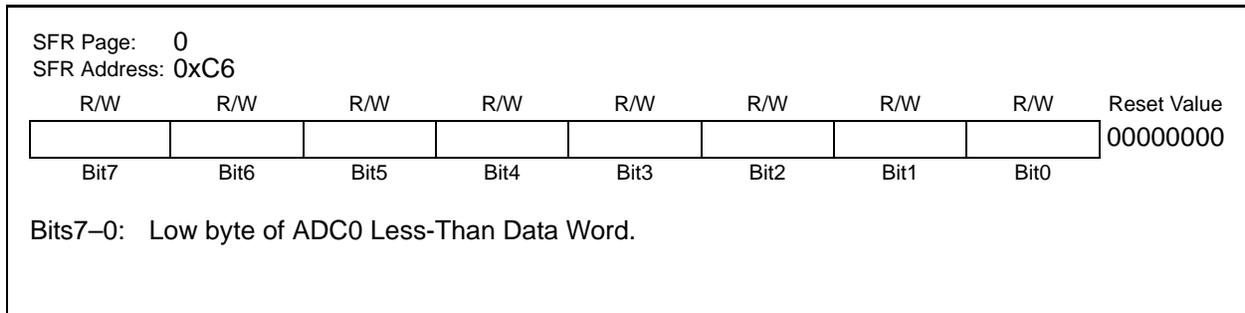
Figure 5.2. Typical Temperature Sensor Transfer Function

C8051F120/1/2/3/4/5/6/7 C8051F130/1/2/3

SFR Definition 5.9. ADC0LTH: ADC0 Less-Than Data High Byte



SFR Definition 5.10. ADC0LTL: ADC0 Less-Than Data Low Byte



C8051F120/1/2/3/4/5/6/7 C8051F130/1/2/3

SFR Definition 6.3. ADC0CF: ADC0 Configuration

SFR Page: 0
SFR Address: 0xBC

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
AD0SC4	AD0SC3	AD0SC2	AD0SC1	AD0SC0	AMP0GN2	AMP0GN1	AMP0GN0	11111000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

Bits7–3: AD0SC4–0: ADC0 SAR Conversion Clock Period Bits.
SAR Conversion clock is derived from system clock by the following equation, where *AD0SC* refers to the 5-bit value held in AD0SC4-0, and CLK_{SAR0} refers to the desired ADC0 SAR clock (Note: the ADC0 SAR Conversion Clock should be less than or equal to 2.5 MHz).

$$AD0SC = \frac{SYSCLK}{2 \times CLK_{SAR0}} - 1 \quad (AD0SC > 00000b)$$

When the AD0SC bits are equal to 00000b, the SAR Conversion clock is equal to SYSCLK to facilitate faster ADC conversions at slower SYSCLK speeds.

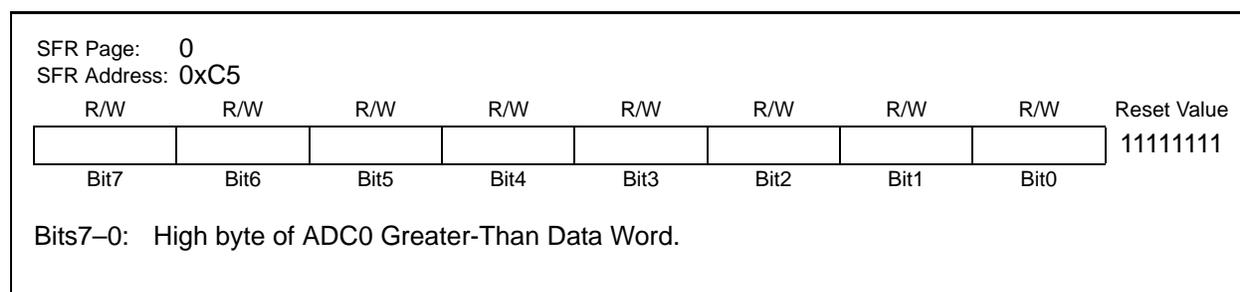
Bits2–0: AMP0GN2–0: ADC0 Internal Amplifier Gain (PGA).
000: Gain = 1
001: Gain = 2
010: Gain = 4
011: Gain = 8
10x: Gain = 16
11x: Gain = 0.5

C8051F120/1/2/3/4/5/6/7 C8051F130/1/2/3

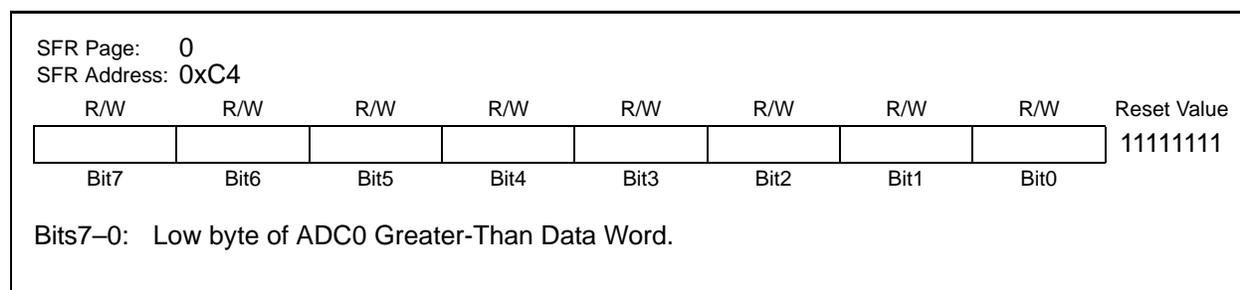
6.3. ADC0 Programmable Window Detector

The ADC0 Programmable Window Detector continuously compares the ADC0 output to user-programmed limits, and notifies the system when an out-of-bound condition is detected. This is especially effective in an interrupt-driven system, saving code space and CPU bandwidth while delivering faster system response times. The window detector interrupt flag (AD0WINT in ADC0CN) can also be used in polled mode. The high and low bytes of the reference words are loaded into the ADC0 Greater-Than and ADC0 Less-Than registers (ADC0GTH, ADC0GTL, ADC0LTH, and ADC0LTL). Reference comparisons are shown starting on page 87. Notice that the window detector flag can be asserted when the measured data is inside or outside the user-programmed limits, depending on the programming of the ADC0GTx and ADC0LTx registers.

SFR Definition 6.7. ADC0GTH: ADC0 Greater-Than Data High Byte



SFR Definition 6.8. ADC0GTL: ADC0 Greater-Than Data Low Byte



C8051F120/1/2/3/4/5/6/7 C8051F130/1/2/3

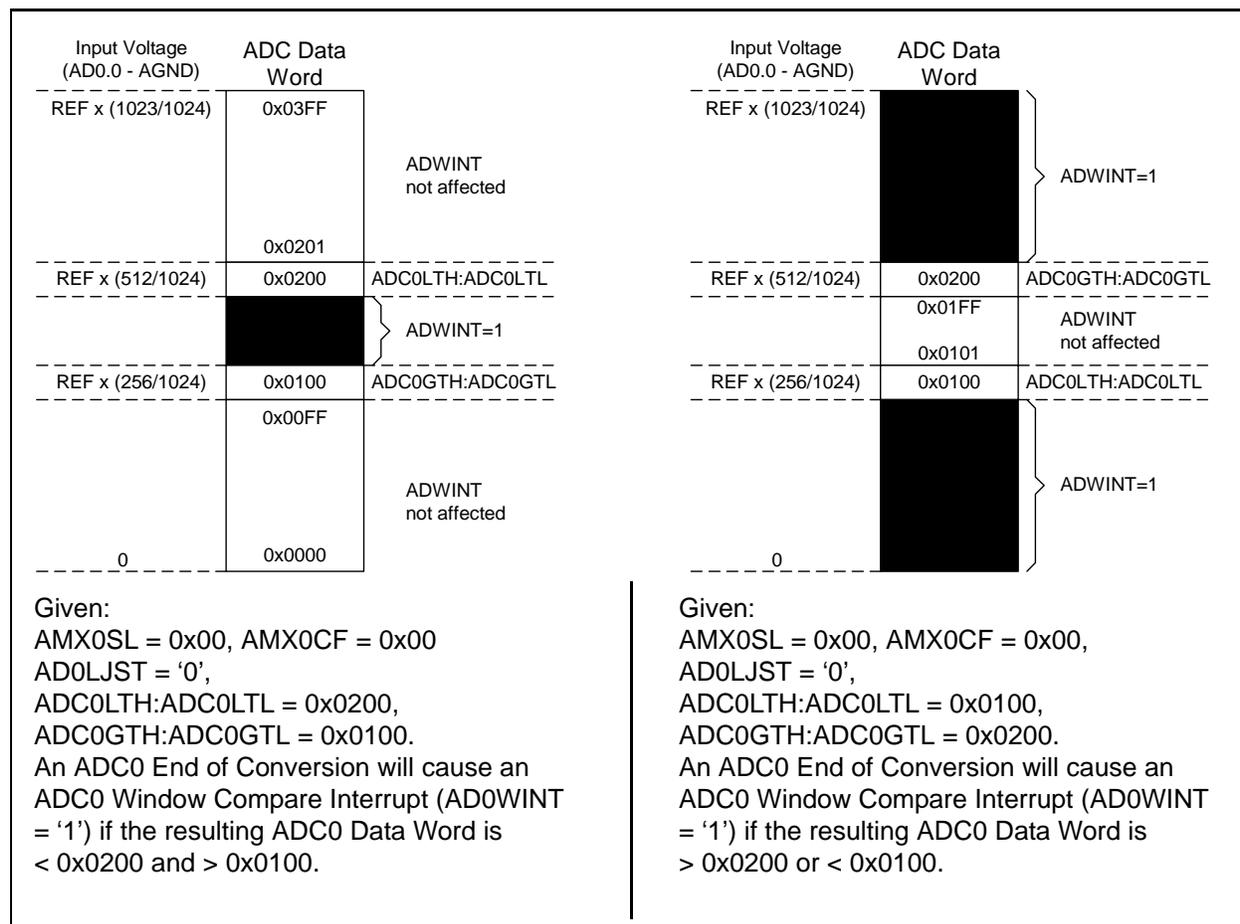


Figure 6.6. 10-Bit ADC0 Window Interrupt Example: Right Justified Single-Ended Data

C8051F120/1/2/3/4/5/6/7 C8051F130/1/2/3

SFR Definition 8.4. DAC1H: DAC1 High Byte

R/W	Reset Value							
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0xD3
SFR Page: 1

Bits7–0: DAC1 Data Word Most Significant Byte.

SFR Definition 8.5. DAC1L: DAC1 Low Byte

R/W	Reset Value							
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0xD2
SFR Page: 1

Bits7–0: DAC1 Data Word Least Significant Byte.

9. Voltage Reference

The voltage reference options available on the C8051F12x and C8051F13x device families vary according to the device capabilities.

All devices include an internal voltage reference circuit, consisting of a 1.2 V, 15 ppm/°C (typical) bandgap voltage reference generator and a gain-of-two output buffer amplifier. The internal reference may be routed via the VREF pin to external system components or to the voltage reference input pins. The maximum load seen by the VREF pin must be less than 200 μ A to AGND. Bypass capacitors of 0.1 μ F and 4.7 μ F are recommended from the VREF pin to AGND.

The Reference Control Register, REF0CN enables/disables the internal reference generator and the internal temperature sensor on all devices. The BIASE bit in REF0CN enables the on-board reference generator while the REFBE bit enables the gain-of-two buffer amplifier which drives the VREF pin. When disabled, the supply current drawn by the bandgap and buffer amplifier falls to less than 1 μ A (typical) and the output of the buffer amplifier enters a high impedance state. If the internal bandgap is used as the reference voltage generator, BIASE and REFBE must both be set to logic 1. If the internal reference is not used, REFBE may be set to logic 0. Note that the BIASE bit must be set to logic 1 if any DACs or ADCs are used, regardless of whether the voltage reference is derived from the on-chip reference or supplied by an off-chip source. If no ADCs or DACs are being used, both of these bits can be set to logic 0 to conserve power.

When enabled, the temperature sensor connects to the highest order input of the ADC0 input multiplexer. The TEMPE bit within REF0CN enables and disables the temperature sensor. While disabled, the temperature sensor defaults to a high impedance state. Any ADC measurements performed on the sensor while disabled will result in undefined data.

The electrical specifications for the internal voltage reference are given in Table 9.1.

9.1. Reference Configuration on the C8051F120/2/4/6

On the C8051F120/2/4/6 devices, the REF0CN register also allows selection of the voltage reference source for ADC0 and ADC2, as shown in SFR Definition 9.1. Bits AD0VRS and AD2VRS in the REF0CN register select the ADC0 and ADC2 voltage reference sources, respectively. Three voltage reference input pins allow each ADC and the two DACs to reference an external voltage reference or the on-chip voltage reference output (with an external connection). ADC0 may also reference the DAC0 output internally, and ADC2 may reference the analog power supply voltage, via the VREF multiplexers shown in Figure 9.1.

C8051F120/1/2/3/4/5/6/7 C8051F130/1/2/3

13.1. Power-on Reset

The C8051F120/1/2/3/4/5/6/7 family incorporates a power supply monitor that holds the MCU in the reset state until V_{DD} rises above the V_{RST} level during power-up. See Figure 13.2 for timing diagram, and refer to Table 13.1 for the Electrical Characteristics of the power supply monitor circuit. The \overline{RST} pin is asserted low until the end of the 100 ms V_{DD} Monitor timeout in order to allow the V_{DD} supply to stabilize. The V_{DD} Monitor reset is enabled and disabled using the external V_{DD} monitor enable pin (MONEN). When the V_{DD} Monitor is enabled, it is selected as a reset source using the PORSF bit. If the RSTSRC register is written by firmware, PORSF (RSTSRC.1) must be written to '1' for the V_{DD} Monitor to be effective.

On exit from a power-on reset, the PORSF flag (RSTSRC.1) is set by hardware to logic 1. All of the other reset flags in the RSTSRC Register are indeterminate. PORSF is cleared by all other resets. Since all resets cause program execution to begin at the same location (0x0000) software can read the PORSF flag to determine if a power-up was the cause of reset. The contents of internal data memory should be assumed to be undefined after a power-on reset.

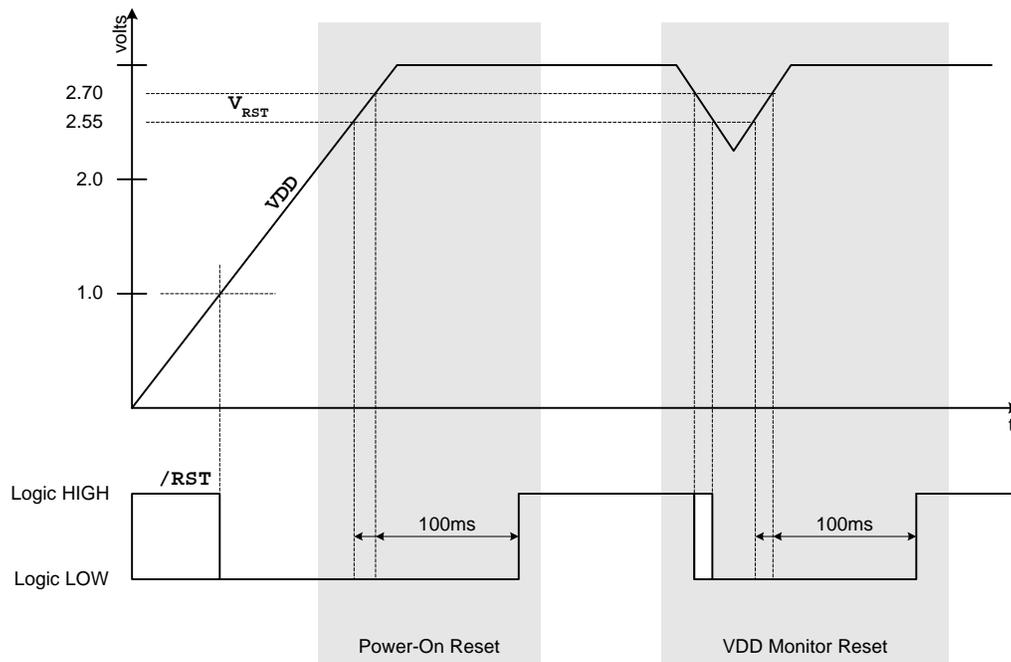


Figure 13.2. Reset Timing

13.2. Power-fail Reset

When a power-down transition or power irregularity causes V_{DD} to drop below V_{RST} , the power supply monitor will drive the \overline{RST} pin low and return the CIP-51 to the reset state. When V_{DD} returns to a level above V_{RST} , the CIP-51 will leave the reset state in the same manner as that for the power-on reset (see Figure 13.2). Note that even though internal data memory contents are not altered by the power-fail reset, it is impossible to determine if V_{DD} dropped below the level required for data retention. If the PORSF flag is set to logic 1, the data may no longer be valid.

C8051F120/1/2/3/4/5/6/7 C8051F130/1/2/3

SFR Definition 14.6. PLL0DIV: PLL Pre-divider

R/W	Reset Value							
-	-	-	PLL4	PLL3	PLL2	PLL1	PLL0	00000001
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0x8D
SFR Page: F

Bits 7–5: UNUSED: Read = 000b; Write = don't care.
Bits 4–0: PLL4–0: PLL Reference Clock Pre-divider.
These bits select the pre-divide value of the PLL reference clock. When set to any non-zero value, the reference clock will be divided by the value in PLL4–0. When set to '00000b', the reference clock will be divided by 32.

SFR Definition 14.7. PLL0MUL: PLL Clock Scaler

R/W	Reset Value							
PLL7	PLL6	PLL5	PLL4	PLL3	PLL2	PLL1	PLL0	00000001
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0x8E
SFR Page: F

Bits 7–0: PLL7–0: PLL Multiplier.
These bits select the multiplication factor of the divided PLL reference clock. When set to any non-zero value, the multiplication factor will be equal to the value in PLL7-0. When set to '0000000b', the multiplication factor will be equal to 256.

17.5.3. Split Mode with Bank Select

When EMI0CF.[3:2] are set to '10', the XRAM memory map is split into two areas, on-chip space and off-chip space.

- Effective addresses below the 8k boundary will access on-chip XRAM space.
- Effective addresses above the 8k boundary will access off-chip space.
- 8-bit MOVX operations use the contents of EMI0CN to determine whether the memory access is on-chip or off-chip. The upper 8-bits of the Address Bus A[15:8] are determined by EMI0CN, and the lower 8-bits of the Address Bus A[7:0] are determined by R0 or R1. All 16-bits of the Address Bus A[15:0] are driven in "Bank Select" mode.
- 16-bit MOVX operations use the contents of DPTR to determine whether the memory access is on-chip or off-chip, and the full 16-bits of the Address Bus A[15:0] are driven during the off-chip transaction.

17.5.4. External Only

When EMI0CF[3:2] are set to '11', all MOVX operations are directed to off-chip space. On-chip XRAM is not visible to the CPU. This mode is useful for accessing off-chip memory located between 0x0000 and the 8k boundary.

- 8-bit MOVX operations ignore the contents of EMI0CN. The upper Address bits A[15:8] are not driven (identical behavior to an off-chip access in "Split Mode without Bank Select" described above). This allows the user to manipulate the upper address bits at will by setting the Port state directly. The lower 8-bits of the effective address A[7:0] are determined by the contents of R0 or R1.
- 16-bit MOVX operations use the contents of DPTR to determine the effective address A[15:0]. The full 16-bits of the Address Bus A[15:0] are driven during the off-chip transaction.

17.6. EMIF Timing

The timing parameters of the External Memory Interface can be configured to enable connection to devices having different setup and hold time requirements. The Address Setup time, Address Hold time, /RD and /WR strobe widths, and in multiplexed mode, the width of the ALE pulse are all programmable in units of SYSCLK periods through EMI0TC, shown in SFR Definition 17.3, and EMI0CF[1:0].

The timing for an off-chip MOVX instruction can be calculated by adding 4 SYSCLK cycles to the timing parameters defined by the EMI0TC register. Assuming non-multiplexed operation, the minimum execution time for an off-chip XRAM operation is 5 SYSCLK cycles (1 SYSCLK for /RD or /WR pulse + 4 SYSCLKs). For multiplexed operations, the Address Latch Enable signal will require a minimum of 2 additional SYSCLK cycles. Therefore, the minimum execution time for an off-chip XRAM operation in multiplexed mode is 7 SYSCLK cycles (2 for /ALE + 1 for /RD or /WR + 4). The programmable setup and hold times default to the maximum delay settings after a reset. Table 17.1 lists the ac parameters for the External Memory Interface, and Figure 17.4 through Figure 17.9 show the timing diagrams for the different External Memory Interface modes and MOVX operations.

C8051F120/1/2/3/4/5/6/7 C8051F130/1/2/3

SFR Definition 17.3. EMI0TC: External Memory Timing Control

R/W	Reset Value							
EAS1	EAS0	ERW3	EWR2	EWR1	EWR0	EAH1	EAH0	11111111
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0xA1
SFR Page: 0

Bits7–6: EAS1–0: EMIF Address Setup Time Bits.
 00: Address setup time = 0 SYSCLK cycles.
 01: Address setup time = 1 SYSCLK cycle.
 10: Address setup time = 2 SYSCLK cycles.
 11: Address setup time = 3 SYSCLK cycles.

Bits5–2: EWR3–0: EMIF /WR and /RD Pulse-Width Control Bits.
 0000: /WR and /RD pulse width = 1 SYSCLK cycle.
 0001: /WR and /RD pulse width = 2 SYSCLK cycles.
 0010: /WR and /RD pulse width = 3 SYSCLK cycles.
 0011: /WR and /RD pulse width = 4 SYSCLK cycles.
 0100: /WR and /RD pulse width = 5 SYSCLK cycles.
 0101: /WR and /RD pulse width = 6 SYSCLK cycles.
 0110: /WR and /RD pulse width = 7 SYSCLK cycles.
 0111: /WR and /RD pulse width = 8 SYSCLK cycles.
 1000: /WR and /RD pulse width = 9 SYSCLK cycles.
 1001: /WR and /RD pulse width = 10 SYSCLK cycles.
 1010: /WR and /RD pulse width = 11 SYSCLK cycles.
 1011: /WR and /RD pulse width = 12 SYSCLK cycles.
 1100: /WR and /RD pulse width = 13 SYSCLK cycles.
 1101: /WR and /RD pulse width = 14 SYSCLK cycles.
 1110: /WR and /RD pulse width = 15 SYSCLK cycles.
 1111: /WR and /RD pulse width = 16 SYSCLK cycles.

Bits1–0: EAH1–0: EMIF Address Hold Time Bits.
 00: Address hold time = 0 SYSCLK cycles.
 01: Address hold time = 1 SYSCLK cycle.
 10: Address hold time = 2 SYSCLK cycles.
 11: Address hold time = 3 SYSCLK cycles.

C8051F120/1/2/3/4/5/6/7 C8051F130/1/2/3

Table 18.1. Port I/O DC Electrical Characteristics

$V_{DD} = 2.7$ to 3.6 V, -40 to $+85$ °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
Output High Voltage (V_{OH})	$I_{OH} = -3$ mA, Port I/O Push-Pull $I_{OH} = -10$ μ A, Port I/O Push-Pull $I_{OH} = -10$ mA, Port I/O Push-Pull	$V_{DD} - 0.7$ $V_{DD} - 0.1$	$V_{DD} - 0.8$		V
Output Low Voltage (V_{OL})	$I_{OL} = 8.5$ mA $I_{OL} = 10$ μ A $I_{OL} = 25$ mA		1.0	0.6 0.1	V
Input High Voltage (V_{IH})		$0.7 \times V_{DD}$			
Input Low Voltage (V_{IL})				$0.3 \times V_{DD}$	
Input Leakage Current	DGND < Port Pin < V_{DD} , Pin Tri-state Weak Pullup Off Weak Pullup On		10	± 1	μ A
Input Capacitance			5		pF

C8051F120/1/2/3/4/5/6/7 C8051F130/1/2/3

NOTES:

C8051F120/1/2/3/4/5/6/7 C8051F130/1/2/3

SFR Definition 21.1. SCON0: UART0 Control

R/W	Reset Value							
SM00	SM10	SM20	REN0	TB80	RB80	TIO	RI0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Bit Addressable

SFR Address: 0x98
SFR Page: 0

Bits7–6: SM00–SM10: Serial Port Operation Mode:
Write:
When written, these bits select the Serial Port Operation Mode as follows:

SM00	SM10	Mode
0	0	Mode 0: Synchronous Mode
0	1	Mode 1: 8-Bit UART, Variable Baud Rate
1	0	Mode 2: 9-Bit UART, Fixed Baud Rate
1	1	Mode 3: 9-Bit UART, Variable Baud Rate

Reading these bits returns the current UART0 mode as defined above.

Bit5: SM20: Multiprocessor Communication Enable.
The function of this bit is dependent on the Serial Port Operation Mode.
Mode 0: No effect
Mode 1: Checks for valid stop bit.
0: Logic level of stop bit is ignored.
1: RI0 will only be activated if stop bit is logic level 1.
Mode 2 and 3: Multiprocessor Communications Enable.
0: Logic level of ninth bit is ignored.
1: RI0 is set and an interrupt is generated only when the ninth bit is logic 1 and the received address matches the UART0 address or the broadcast address.

Bit4: REN0: Receive Enable.
This bit enables/disables the UART0 receiver.
0: UART0 reception disabled.
1: UART0 reception enabled.

Bit3: TB80: Ninth Transmission Bit.
The logic level of this bit will be assigned to the ninth transmission bit in Modes 2 and 3. It is not used in Modes 0 and 1. Set or cleared by software as required.

Bit2: RB80: Ninth Receive Bit.
The bit is assigned the logic level of the ninth bit received in Modes 2 and 3. In Mode 1, if SM20 is logic 0, RB80 is assigned the logic level of the received stop bit. RB8 is not used in Mode 0.

Bit1: TIO: Transmit Interrupt Flag.
Set by hardware when a byte of data has been transmitted by UART0 (after the 8th bit in Mode 0, or at the beginning of the stop bit in other modes). When the UART0 interrupt is enabled, setting this bit causes the CPU to vector to the UART0 interrupt service routine. This bit must be cleared manually by software

Bit0: RI0: Receive Interrupt Flag.
Set by hardware when a byte of data has been received by UART0 (as selected by the SM20 bit). When the UART0 interrupt is enabled, setting this bit causes the CPU to vector to the UART0 interrupt service routine. This bit must be cleared manually by software.

C8051F120/1/2/3/4/5/6/7 C8051F130/1/2/3

SFR Definition 21.3. SBUF0: UART0 Data Buffer

R/W	Reset Value							
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0x99
SFR Page: 0

Bits7–0: SBUF0.[7:0]: UART0 Buffer Bits 7–0 (MSB–LSB)
This is actually two registers; a transmit and a receive buffer register. When data is moved to SBUF0, it goes to the transmit buffer and is held for serial transmission. Moving a byte to SBUF0 is what initiates the transmission. When data is moved from SBUF0, it comes from the receive buffer.

SFR Definition 21.4. SADDR0: UART0 Slave Address

R/W	Reset Value							
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0xA9
SFR Page: 0

Bits7–0: SADDR0.[7:0]: UART0 Slave Address
The contents of this register are used to define the UART0 slave address. Register SADEN0 is a bit mask to determine which bits of SADDR0 are checked against a received address: corresponding bits set to logic 1 in SADEN0 are checked; corresponding bits set to logic 0 are “don’t cares”.

SFR Definition 21.5. SADEN0: UART0 Slave Address Enable

R/W	Reset Value							
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0xB9
SFR Page: 0

Bits7–0: SADEN0.[7:0]: UART0 Slave Address Enable
Bits in this register enable corresponding bits in register SADDR0 to determine the UART0 slave address.
0: Corresponding bit in SADDR0 is a “don’t care”.
1: Corresponding bit in SADDR0 is checked against a received address.

C8051F120/1/2/3/4/5/6/7 C8051F130/1/2/3

SFR Definition 23.5. TL1: Timer 1 Low Byte

R/W	Reset Value							
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0x8B
SFR Page: 0

Bits 7–0: TL1: Timer 1 Low Byte.
The TL1 register is the low byte of the 16-bit Timer 1.

SFR Definition 23.6. TH0: Timer 0 High Byte

R/W	Reset Value							
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0x8C
SFR Page: 0

Bits 7–0: TH0: Timer 0 High Byte.
The TH0 register is the high byte of the 16-bit Timer 0.

SFR Definition 23.7. TH1: Timer 1 High Byte

R/W	Reset Value							
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0x8D
SFR Page: 0

Bits 7–0: TH1: Timer 1 High Byte.
The TH1 register is the high byte of the 16-bit Timer 1.

C8051F120/1/2/3/4/5/6/7 C8051F130/1/2/3

SFR Definition 24.2. PCA0MD: PCA0 Mode

R/W	Reset Value							
CIDL	-	-	-	CPS2	CPS1	CPS0	ECF	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0xD9
SFR Page: 0

- Bit7:** CIDL: PCA0 Counter/Timer Idle Control.
Specifies PCA0 behavior when CPU is in Idle Mode.
0: PCA0 continues to function normally while the system controller is in Idle Mode.
1: PCA0 operation is suspended while the system controller is in Idle Mode.
- Bits6–4:** UNUSED. Read = 000b, Write = don't care.
- Bits3–1:** CPS2-CPS0: PCA0 Counter/Timer Pulse Select.
These bits select the timebase source for the PCA0 counter

CPS2	CPS1	CPS0	Timebase
0	0	0	System clock divided by 12
0	0	1	System clock divided by 4
0	1	0	Timer 0 overflow
0	1	1	High-to-low transitions on ECI (max rate = system clock divided by 4)
1	0	0	System clock
1	0	1	External clock divided by 8 (synchronized with system clock)
1	1	0	Reserved
1	1	1	Reserved

- Bit0:** ECF: PCA Counter/Timer Overflow Interrupt Enable.
This bit sets the masking of the PCA0 Counter/Timer Overflow (CF) interrupt.
0: Disable the CF interrupt.
1: Enable a PCA0 Counter/Timer Overflow interrupt request when CF (PCA0CN.7) is set.